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RoHS

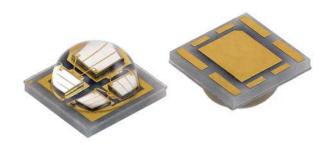
HALOGEN

FREE GREEN



Vishay Semiconductors

UV SMD LED with Silicone Lens



DESCRIPTION

The VLMU5200-...-140 series comprises 3 high brightness UV LED types within an overall wavelength range from 380nm to 410nm. The ceramic based high power package with silicone lens features a good longterm stability against thermal exposure and UV light irradiation and therefore a long life time. The package size is 5.2 mm x 5.2 mm x 3.1 mm, and the radiant power up to 4400 mW at 700 mA, with 4 LED chips connected in series.

PRODUCT GROUP AND PACKAGE DATA

Product group: LED

Package: SMD ceramic high powerProduct series: high power UV LED

• Angle of half intensity: ± 70°

• Lead-finishing: Au

SAFETY ADVICES

Depending on the mode of operation, these devices emit highly concentrated non visible ultraviolet light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 62471 "Photobiological Safety of Lamp and Lamp Systems".

FEATURES

- Ceramic SMT package with silicone lens
- Dimensions (L x W x H) in mm: 5.2 x 5.2 x 3.1
- Forward current: up to 700 mA
- Radiant power (typ.): 2500 mW at 500 mA, 3600 mW at 700 mA
- · Materials:
 - Die: InGaN
 - Resin: silicone (water clear)L / F finish: AIN with Au plating
- · Grouping parameters:
 - Radiant power
 - Peak wavelength
 - Forward voltage
- · Reflow soldering method
- MSL2 according to J-STD-020
- Packaging: 12 mm tape with 100 pieces per reel, Ø 180 mm (7")
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Industrial curing
- Photocatalytic purification
- Poster printing curing
- · Counterfeit money detector
- Blood detector
- Nail curing
- Teeth curing

PARTS TABLE														
PART COL		RADIANT POWER (mW)		at I _F	WAVELENGTH (nm)		at I _F	FORWARD VOLTAGE (V)		at I _F (mA)	TECHNOLOGY			
		MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(IIIA)	
VLMU5200-385-140	Ultraviolet	1800	2500	3300	500	380	385	390	500	13	14.5	16	500	InGaN
VLMU5200-395-140	Ultraviolet	1800	2500	3300	500	390	395	400	500	13	14.5	16	500	InGaN
VLMU5200-405-140	Ultraviolet	1800	2500	3300	500	400	405	410	500	13	14.5	16	500	InGaN



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) VLMU5200140							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
DC forward current		I _F	700	mA			
Power dissipation		P _V	11.2	W			
Electrostatic discharge	HBM: MIL-STD-883 C 3B	ESD	2000	V			
Junction temperature		Tj	+150	°C			
Operating temperature range		T _{amb}	-40 to +85	°C			
Storage temperature range		T _{stg}	-40 to +100	°C			
Solder temperature		T _{sol}	260	°C			
Thermal resistance - junction to solder point		R _{thJS}	2.4	°C/W			

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25$ °C, unless otherwise specified) VLMU5200140, ULTRAVIOLET								
PARAMETER	TEST CONDITION	DEVICE TYPE	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Forward voltage	I _F = 500 mA		V _F	13.0	14.5	16.0	V	
Radiant power	I _F = 350 mA I _F = 500 mA		фе	1300	1950	2350	mW	
				1800	2500	3300		
	I _F = 700 mA			2480	3600	4400		
Ratio: radiant intensity / radiant power	I _F = 500 mA		l _e	-	0.28	-	sr-1	
		VLMU5200-385-140		380	385	390	nm	
Peak wavelength	$I_F = 500 \text{ mA}$	VLMU5200-395-140	λ_{p}	390	395	400	nm	
		VLMU5200-405-140		400	405	410	nm	
Angle of half intensity	I _F = 500 mA		φ	-	± 70	-	deg	

Note

• Tolerances: \pm 11 % for ϕ_e , \pm 0.1 V for V_F , \pm 2 nm for λ_p .

RADIANT POWER CLASSIFICATION (I _F = 500 mA)							
GROUP	MIN.	MAX.	UNIT				
PA8	1800	1900					
PA9	1900	2000					
PB0	2000	2100					
PB1	2100	2200					
PB2	2200	2300					
PB3	2300	2400					
PB4	2400	2500					
PB5	2500	2600	mW				
PB6	2600	2700					
PB7	2700	2800					
PB8	2800	2900					
PB9	2900	3000					
PC0	3000	3100					
PC1	3100	3200					
PC2	3200	3300					



PEAK WAVELENGTH CLASSIFICATION (I _F = 500 mA)							
GROUP	MIN.	MAX.	UNIT				
Q380	380	385					
Q385	385	390					
Q390	390	395	nm				
Q395	395	400	nm				
Q400	400	405					
Q405	405	410					

FORWARD VOLTAGE CLASSIFICATION (I _F = 500 mA)						
GROUP	MIN.	MAX.	UNIT			
W1314	13.0	14.0				
W1415	14.0	15.0	V			
W1516	15.0	16.0				

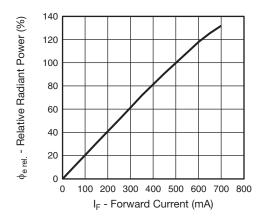
Note

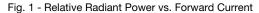
MARKING EXAMPLE FOR SELECTION CODE ON LABEL

Selection code: PA9Q385W1415

 $\begin{aligned} PA9 &\rightarrow \varphi_{e} \\ Q385 &\rightarrow \lambda_{p} \\ W1415 &\rightarrow V_{F} \end{aligned}$

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)





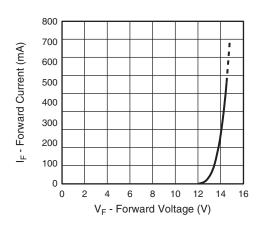


Fig. 2 - Forward Current vs. Forward Voltage

[•] In order to ensure availability, single groups for radiant intensity, wavelength, and forward voltage will not be orderable. Only one group for radiant intensity, wavelength, and forward voltage will be shipped in any one reel.

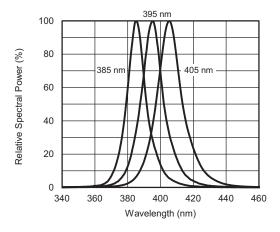


Fig. 3 - Relative Spectral Power vs. Wavelength

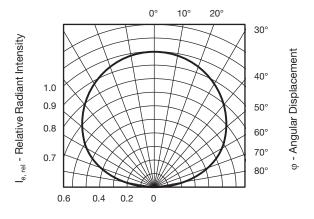


Fig. 4 - Relative Intensity vs. Wavelength

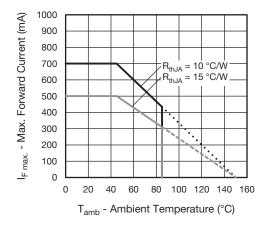


Fig. 5 - Maximum Forward Current vs. Ambient Temperature

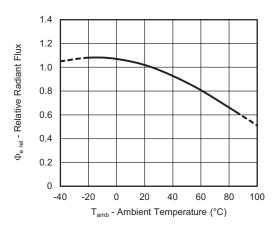


Fig. 6 - Relative Radiant Flux vs. Ambient Temperature

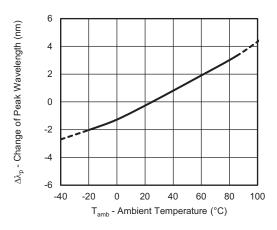


Fig. 7 - Change of Peak Wavelength vs. Ambient Temperature

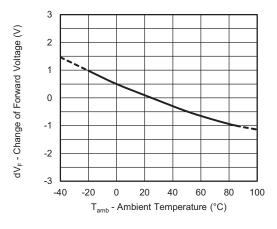
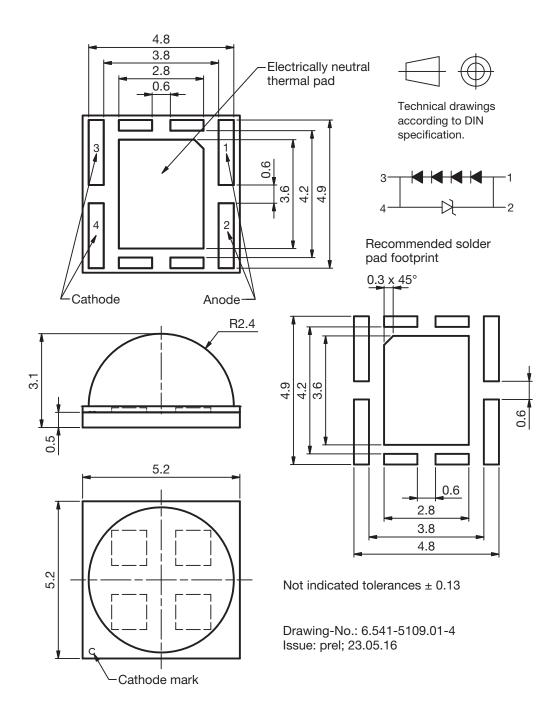


Fig. 8 - Change of Forward Voltage vs. Ambient Temperature

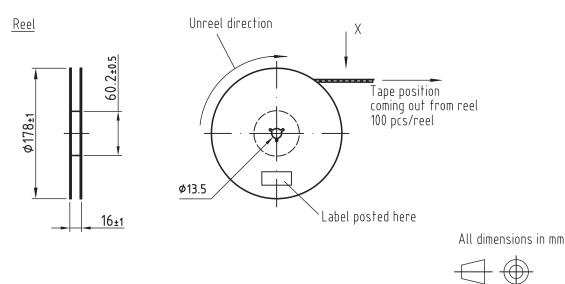
PACKAGE DIMENSIONS in millimeters



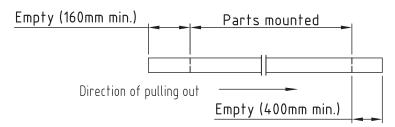


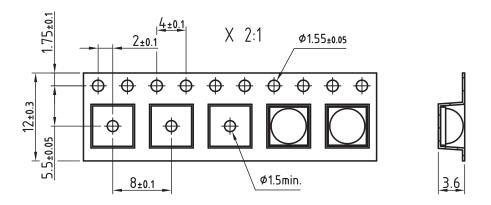
technical drawings according to DIN specifications

TAPE AND REEL DIMENSIONS in millimeters



Leader and trailer tape:

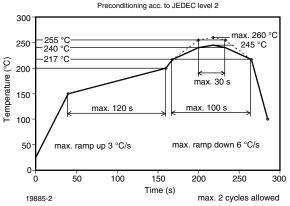




Drawing refers to following types: VLMU5200-385-140 Drawing-No.: 9.800-5135.01-4

Reel dimensions and tape Issue: prel; 29.05.15

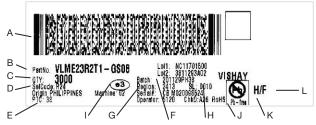
SOLDERING PROFILE



IR Reflow Soldering Profile for Lead (Pb)-free Soldering

Fig. 9 - Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020C)

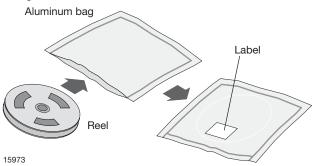
BAR CODE PRODUCT LABEL (example only)



- A. 2D barcode
- B. Vishay part number
- C. Quantity
- D. SEL = selection code (binning)
- E. Code of manufacturing plant
- F. Batch = date code: year / week / plant code
- G. Region code
- H. SL = sales location
- I. Terminations finishing
- J. Lead (Pb)-free symbol
- K. Halogen-free symbol
- L. RoHS symbol

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 1 year under these conditions moisture content will be too high for reflow soldering.

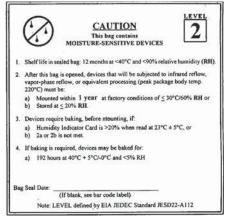
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

24 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JESD22-A112 level 2 label is included on all dry bags.



1702

Example of JESD22-A112 level 2 label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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Vishay

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